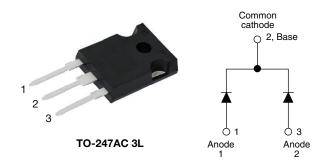


# Ultrafast Rectifier, 2 x 30 A FRED Pt®



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	2 x 30 A					
$V_{R}$	400 V					
V <sub>F</sub> at I <sub>F</sub>	0.92 V					
t <sub>rr</sub> typ.	37 ns					
T <sub>J</sub> max.	175 °C					
Package	TO-247AC 3L					
Circuit configuration	Common cathode					

#### **FEATURES**

- Low forward voltage drop
- 175 °C operating junction temperature
- · Ultrafast recovery time
- · Low leakage current
- Designed and qualified according to JEDEC®-JESD 47





#### **DESCRIPTION / APPLICATIONS**

VS-60CPU04... series are the state of the art ultrafast recovery rectifiers designed with optimized performance of forward voltage drop and ultrafast recovery time.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, welding, UPS, DC/DC converters as well as freewheeling diodes in low voltage inverters, and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS			
Peak repetitive reverse voltage	V <sub>RRM</sub>		400	V			
Average rectified forward current per leg	I <sub>F(AV)</sub>	Rated V <sub>R</sub> , T <sub>C</sub> = 134 °C	30	A			
per device			60				
Non-repetitive peak surge current per leg	I <sub>FSM</sub>	$T_{J} = 25  ^{\circ}\text{C},  t_{p} = 10  \text{ms}$	300	A			
Peak repetitive forward current per leg	I <sub>FM</sub>	Rated $V_R$ , square wave, 20 kHz, $T_C = 134$ °C	60				
Operating junction and storage temperatures	$T_J, T_{Stg}$		-65 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	Ι <sub>R</sub> = 100 μΑ	400	-	-			
Fan word walks as		I <sub>F</sub> = 30 A	-	1.10	1.30	V		
	V <sub>F</sub>	I <sub>F</sub> = 30 A, T <sub>J</sub> = 150 °C	-	0.92	1.10	v		
Forward voltage		I <sub>F</sub> = 60 A	-	1.25	1.6			
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 150 °C	-	1.10	1.4			
Payaraa laakaga aurrant	I <sub>R</sub>	$V_R = V_R$ rated	-	-	10			
Reverse leakage current		$T_J = 150 ^{\circ}\text{C},  V_R = V_R  \text{rated}$	-	-	100	μA		
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 400 V	-	40	-	pF		
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	12	-	nH		



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	MIN.	TYP.	MAX.	UNITS		
		I <sub>F</sub> = 1.0 A, di <sub>F</sub> /dt = 100	) A/μs, V <sub>R</sub> = 30 V	-	37	40		
Poverse recovery time		$I_F = 1.0 \text{ A}, \text{ di}_F/\text{dt} = 50 \text{ A/}\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	46	-		
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 30 A di <sub>F</sub> /dt = 200 A/μs V <sub>R</sub> = 200 V	-	65	-	ns - A	
		T <sub>J</sub> = 125 °C		-	119	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	6.4	-		
		T <sub>J</sub> = 125 °C		-	14.7	-		
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	206	-	nC	
		T <sub>J</sub> = 125 °C		-	874	-		

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	+175	°C	
Thermal resistance, junction to case per leg	R <sub>thJC</sub>		-	0.6	1.0		
Thermal resistance, junction to ambient per leg	R <sub>thJA</sub>	Typical socket mount	-	-	40	°C/W	
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth, and greased	-	0.5	-		
\Maight			-	6	-	g	
Weight			-	0.21	-	oz.	
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)	
Marking device		Case style TO-247AC 3L		60CI	PU04		

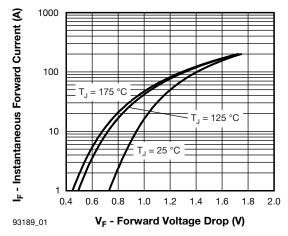


Fig. 1 - Typical Forward Voltage Drop Characteristics

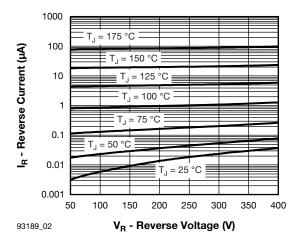


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

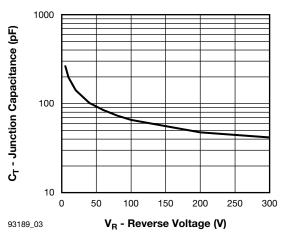


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

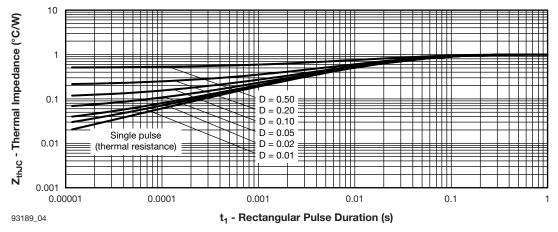


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

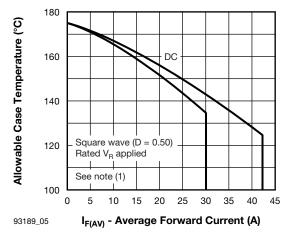


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

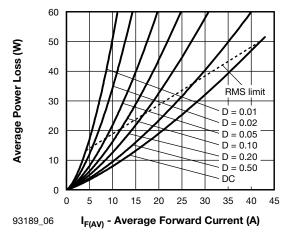
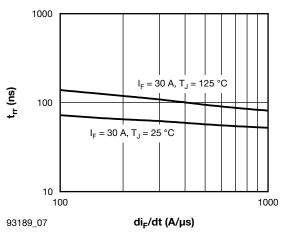


Fig. 6 - Forward Power Loss Characteristics



#### www.vishay.com

## Vishay Semiconductors



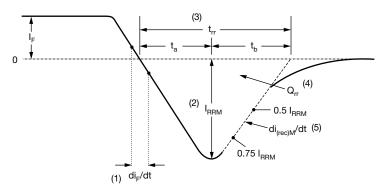
10 000 I<sub>F</sub> = 30 A, T<sub>J</sub> = 125 °C 1000 100 1000 1000 1000 1000 1000

Fig. 7 - Typical Reverse Recovery Time vs. di<sub>F</sub>/dt

Fig. 8 - Typical Stored Charge vs. di<sub>F</sub>/dt

#### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (Pd + Pd_{REV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see fig. 6)}; \\ Pd_{REV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D)}; I_R \text{ at } V_{R1} = \text{rated } V_R \\ \end{array}$ 



- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3)  $\rm t_{rr}$  reverse recovery time measured from zero crossing point of negative going  $\rm I_F$  to point where a line passing through 0.75  $\rm I_{RRM}$  and 0.50  $\rm I_{RRM}$  extrapolated to zero current.
- (4)  ${\rm Q_{rr}}$  area under curve defined by  ${\rm t_{rr}}$  and  ${\rm I_{RRM}}$

$$Q_{rr} = \frac{t_{rr} x I_{RRM}}{2}$$

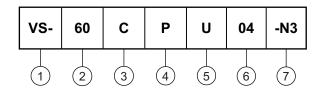
(5) di<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 9 - Reverse Recovery Waveform and Definitions



#### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Current rating (60 = 60 A)

3 - Circuit configuration: C = common cathode

**4** - P = TO-247AC

5 - U = ultrafast rectifier

6 - Voltage rating (04 = 400 V)

7 - Environmental digit:

-N3 = halogen-free, RoHS-compliant and totally lead (Pb)-free

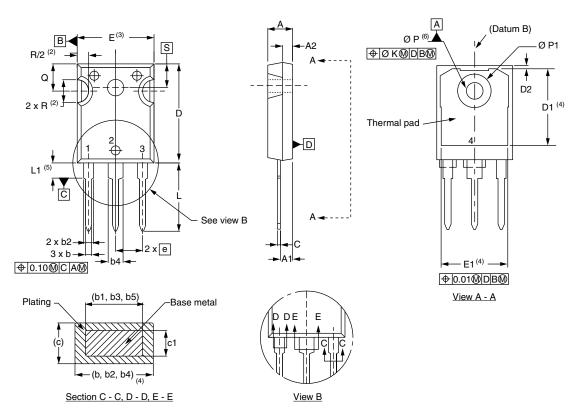
ORDERING INFORMATION (Example)							
PREFERRED P/N QUANTITY PER TUBE MINIMUM ORDER QUANTITY PACKAGING DESCRIPTION							
VS-60CPU04-N3	25	500	Antistatic plastic tube				

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96138				
Part marking information	www.vishay.com/doc?95007				
SPICE model	www.vishay.com/doc?95398				



### **TO-247AC 3L**

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	MILLIMETERS		INCHES	
STWIBOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.17	1.37	0.046	0.054	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIN	MILLIMETERS		INCHES		
OTWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
D2	0.51	1.35	0.020	0.053		
E	15.29	15.87	0.602	0.625	3	
E1	13.46	-	0.53	-		
е	5.46	BSC	0.215	BSC		
ØK	0.2	254	0.010			
L	14.20	16.10	0.559	0.634		
L1	3.71	4.29	0.146	0.169		
ØΡ	3.56	3.66	0.14	0.144		
Ø P1	-	7.39	-	0.291		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51	BSC	0.217 BSC			
	·		·	·	·	

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension Q



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